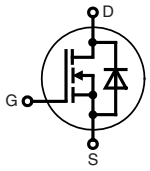
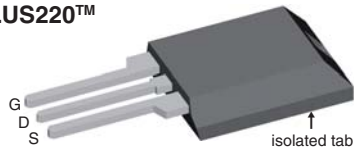
CoolMOS™ [1] Power MOSFET

V_{DSS} = 600 V
I_{D25} = 28 A
$R_{DS(on)\ max}$ = 95 mΩ

Electrically isolated back surface
2500 V electrical isolation
N-Channel Enhancement Mode
Low R_{DSon}, high V_{DSS} MOSFET
Ultra low gate charge



ISOPLUS220™



E72873

MOSFET			
Symbol	**Conditions**	**Maximum Ratings**	
V_{DSS}	T_{VJ} = 25°C	600	V
V_{GS}		± 20	V
I_{D25}	T_C = 25°C	28	A
I_{D90}	T_C = 90°C	19.2	A
E_{AS}	single pulse; I_D = 10 A; T_C = 25°C	690	mJ
E_{AR}	repetitive; I_D = 20 A; T_C = 25°C	1	mJ

Symbol	Conditions	Characteristic Values (T_{VJ} = 25°C, unless otherwise specified)			
		min.	typ.	max.	
R_{DSon}	V_{GS} = 10 V; I_D = 28 A		80	95	mΩ
$V_{GS(th)}$	V_{DS} = V_{GS}; I_D = 2 mA	2.1		3.9	V
I_{DSS}	V_{DS} = 600 V; V_{GS} = 0 V; T_{VJ} = 25°C			50	µA
	V_{DS} = 600 V; V_{GS} = 0 V; T_{VJ} = 150°C			500	µA
I_{GSS}	V_{GS} = ± 20 V; V_{DS} = 0 V			200	nA
C_{iss}	V_{GS} = 0 V; V_{DS} = 25 V; f = 1 MHz		4800		pF
C_{oss}			1560		pF
Q_g	V_{GS} = 0 to 10 V; V_{DS} = 350 V; I_D = 40 A		175	230	nC
Q_{gs}			22		nC
Q_{gd}			66		nC
$t_{d(on)}$	V_{GS} = 13 V; V_{DS} = 380 V; I_D = 40 A; R_G = 1.5 Ω; T_{VJ} = 125°C		10		ns
t_r			5		ns
$t_{d(off)}$			67		ns
t_f			4.5		ns
R_{thJC}				0.6	K/W

Features

- Silicon chip on Direct-Copper-Bond substrate
  - high power dissipation
  - isolated mounting surface
  - 2500 V electrical isolation
  - low drain to tab capacitance (< 30 pF)
- CoolMOS™ [1] power MOSFET
  - 3rd generation
  - high blocking capability
  - lowest resistance
  - avalanche rated for unclamped inductive switching (UIS)
  - low thermal resistance due to reduced chip thickness
- Enhanced total power density

Applications

- Switched mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)
- Power factor correction (PFC)
- Welding
- Inductive heating
- PDP and LCD adapter

Advantages

- Easy assembly: no screws or isolation foils required
- Space savings
- High power density
- High reliability

[1] CoolMOS™ is a trademark of Infineon Technologies AG.

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Source-Drain Diode

Symbol	Conditions	Characteristic Values (T_{VJ} = 25°C, unless otherwise specified)			
		min.	typ.	max.	
I_S	V_{GS} = 0 V			40	A
V_{SD}	I_F = 32 A; V_{GS} = 0 V		0.9	1.2	V
t_{rr}	I_F = 40 A; $-di_F/dt$ = 200 A/µs; V_R = 480 V		500	800	ns
Q_{RM}			20		µC
I_{RM}			140		A

Component

Symbol	Conditions	Maximum Ratings	
T_{VJ}	operating	-55...+150	°C
T_{stg}	storage	-55...+150	°C
V_{ISOL}	RMS leads-to-tab, 50/60 Hz, f = 1 minute	2500	V~
F_C	mounting force	11-65 / 2.4-11	N/lb

Symbol	Conditions	Characteristic Values			
		min.	typ.	max.	
R_{thCH}	with heatsink compound		0.2		K/W
Weight			2.7		g

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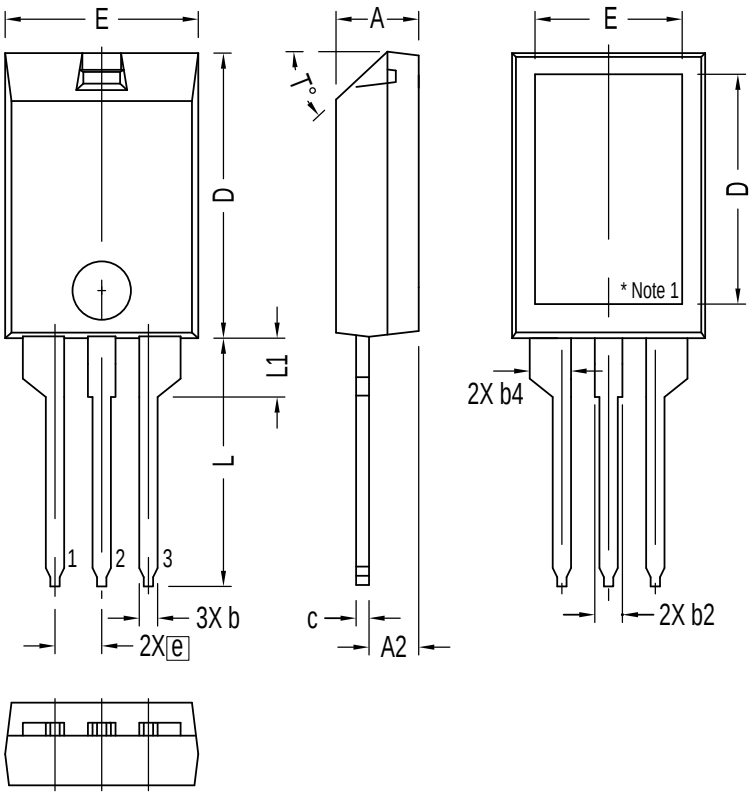
ISOPLUS220™ Outline



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.157	.197	4.00	5.00
A2	.098	.118	2.50	3.00
b	.035	.051	0.90	1.30
b2	.049	.065	1.25	1.65
b4	.093	.100	2.35	2.55
c	.028	.039	0.70	1.00
D	.591	.630	15.00	16.00
D1	.472	.512	12.00	13.00
E	.394	.433	10.00	11.00
E1	.295	.335	7.50	8.50
e	.100 BASIC		2.55 BASIC	
L	.512	.571	13.00	14.50
L1	.118	.138	3.00	3.50
T°			42.5°	47.5°

NOTE:
1. Bottom heatsink is electrically isolated from Pin 1, 2, or 3.
2. This drawing will meet dimensional requirement of JEDEC SS Product Outline TO-273 except D and D1 dimension.

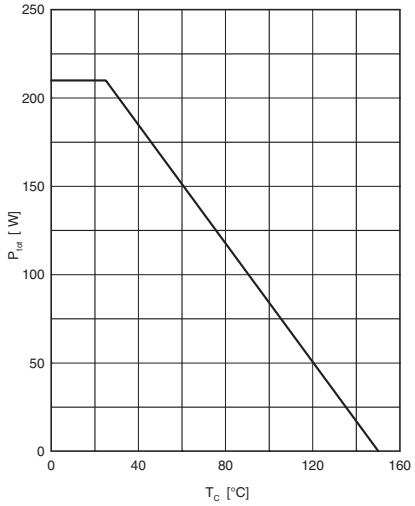


Fig. 1 Power dissipation

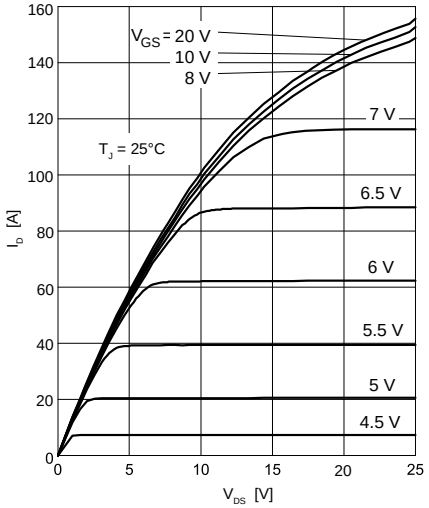


Fig. 2 Typ. output characteristics

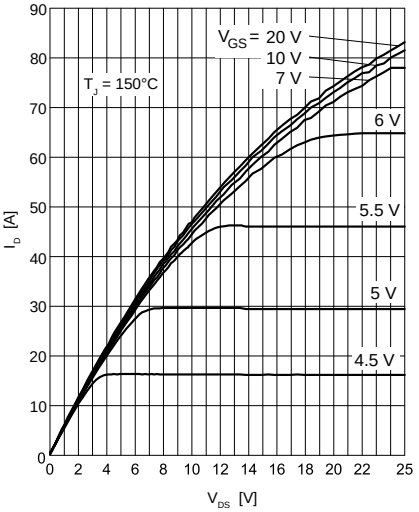


Fig. 3 Typ. output characteristics

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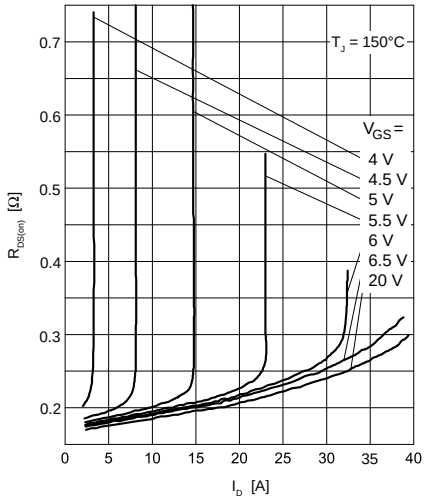

Fig. 4 Typ. drain-source on-state resistance

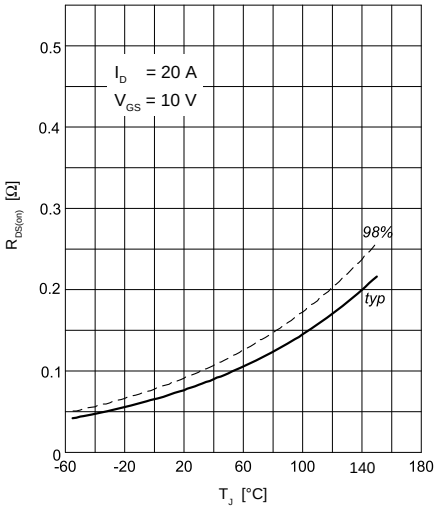

Fig. 5 Drain-source on-state resistance

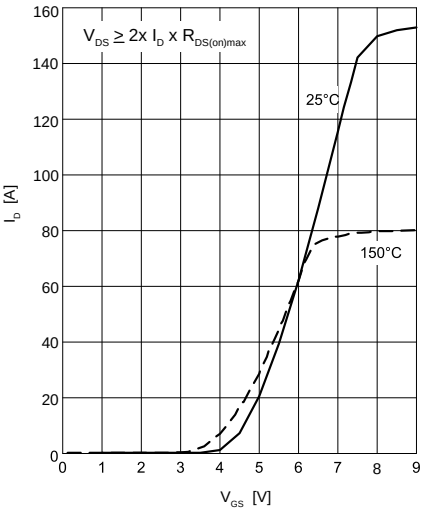

Fig. 6 Typ. transfer characteristics

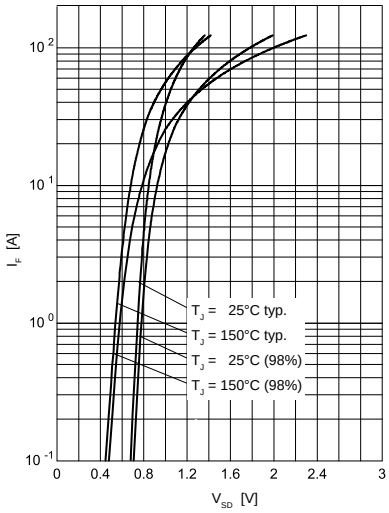

Fig. 7 Forward characteristic of reverse diode

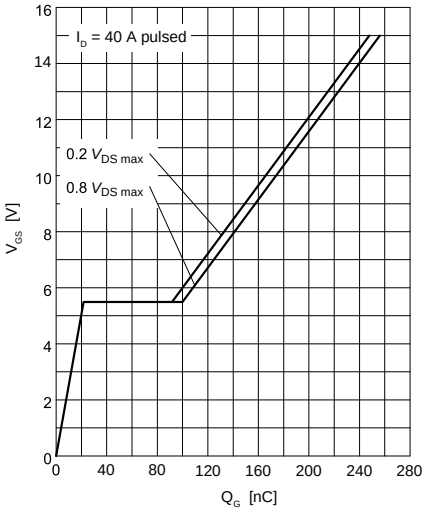

Fig. 8 Typ. gate charge

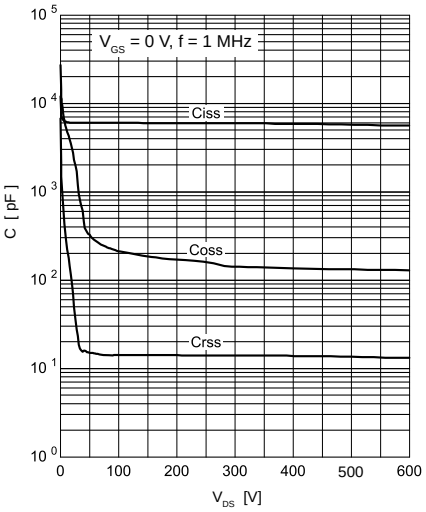

Fig. 9 Typ. capacitances

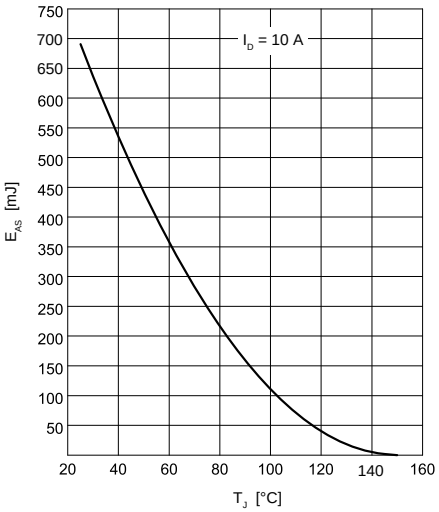

Fig. 10 Avalanche energy

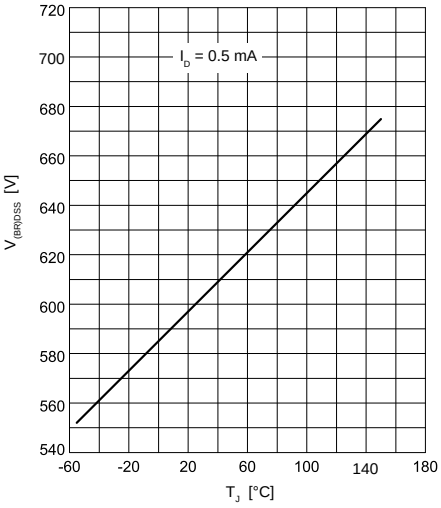

Fig. 11 Drain-source breakdown voltage

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